

#### **Features**

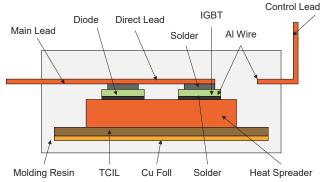
- · Excellent firmness under heating process
- · No warpage after thermal cycling and solderability testing
- · Low thermal expansion coefficient and High thermal conductivity
- · Lower weight than Copper
- · Lower thickness than Copper, and lower to 1mm
- · Pass vibration resistance tests
- · Higher life time than copper after thermal cycling (from Infineon AN2019-05 report, as below pic.)

# **CMC AlSiC Heat Spreader**

**RoHS Compliant** 

## **General Description**

Ceramic matrix compound to increase the thermal conductivity and the efficient heat dissipation at electronic components.

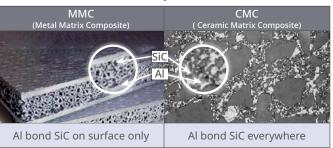


Could be replaced copper (Cu) or molybdenum copper (Mo-Cu)

# **Specification**

Material	Density (g/cm³)	Thermal conductivity ( W/m·K @25°C )	Coefficient of Thermal Expansion (PPM /°C)
85Mo/15Cu	10.01	195	7.0
50Mo/50Cu	9.51	230	10.3
AlSiC	2.7~3.0	>180	7~10
Cu-AlSiC	2.9~3.2	>360	8~12

# CMC AlSiC and MMC Comparison:



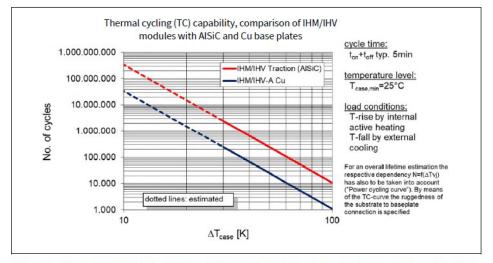


Figure 8 Example for thermal-cycling capability of industrial modules with Cu base plate and traction modules with AlSiC base plate versus the case temperature rise at a fixed minimum case temperature

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